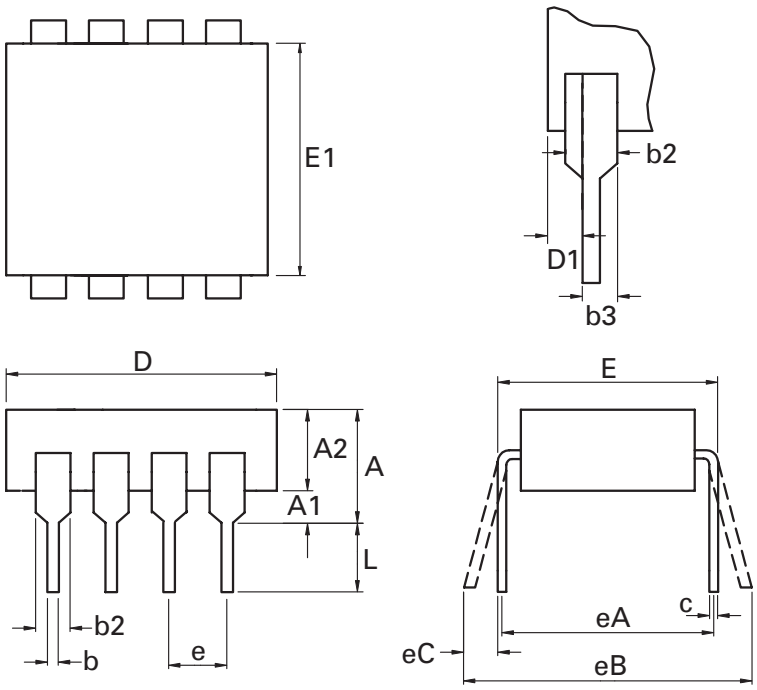
Package information - DIL8

Dual in-line, 8 pin package

Package outline



DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min	Max	Min	Max		Min	Max	Min	Max
A	-	0.210	-	5.33	D1	0.005	-	0.13	-
A1	0.015	-	0.38	-	E	0.300	0.325	7.62	8.26
A2	0.115	0.195	2.92	4.95	E1	0.240	0.280	6.10	7.11
b	0.014	0.022	0.36	0.56	e	0.100 BSC		2.54 BSC	
b2	0.045	0.070	1.14	1.78	eA	0.300 BSC		7.62 BSC	
b3	0.030	0.045	0.76	1.14	eB	-	0.430	-	10.92
c	0.008	0.014	0.20	0.36	eC	0.000	0.060	0.00	1.52
D	0.355	0.400	9.02	10.16	L	0.115	0.150	2.92	3.81

Note: Controlling dimensions are in inches. Approximate dimensions are provided in millimeters

Taping specification

Dual inline devices (DIL8, DIL14, DIL16 and DIL20) are provided in tubes.

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Package information - DIL8

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